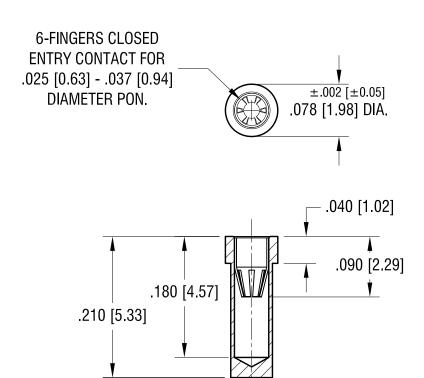
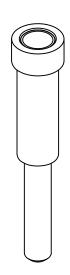
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NOTES:

1. SPRING CONTACT:

MAT'L - BERYLLIUM COPPER

.187 [4.75]

FINISH - GOLD PLATE

BODY

MAT'L - BRASS

FINISH - GOLD PLATE

2. MOUNTING HOLE DIA.: .065 [1.65]

KEYSTONE ELECTRONICS CORP.				
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PART NAME				
MICRO JACK, SOLDER MOUNT				
MATERIAL				
AS NOTED				
FINISH	BOONE DATE 3.6.07			
AS NOTED	APP'D LN SCALE 7X			
TOLERANCES INCH [MM] CODE	DWG NO.			
DECIMAL ± .005 [± 0.13] ANGULAR ± 1° LINI ESS OTHERWISE SPECIFIED	3590			

±.002 [±0.05] .062 [1.57] DIA.

±.002 [±0.05] - .040 [1.02] DIA.

4.12.11	CHANGE AS PER ECN 11-050	Α
DATE	DESCRIPTION	